

Optical Isolators for Photonic Integrated Circuits

Martijn J. R. HECK

Aarhus University, Department of Engineering, Finlandsgade 22, 8200 Aarhus, Denmark
mheck@eng.au.dk

With the advance of mature fabrication technologies, photonic integrated circuits (PICs) reach ever-higher levels of complexity. Integration of thousands of components has been shown [1], with each main technology showing an exponential growth in complexity [2]. This increase in complexity requires a convergence in technologies, and the roadmaps are currently being pushed by silicon nitride, (hybrid) silicon and indium phosphide PIC technologies. This trend is further fuelled by the establishment of PIC foundries for these main PIC technologies.

Although this convergence on a few main PIC platforms and process flows is a requirement for increasing the complexity, yield, uniformity and robustness of PICs, and decreasing the cost, this means that flexibility on the physical level is limited. The emphasis shifts towards the circuit level. Practically this means that challenges for the application need to be solved by clever PIC design, instead of merging new materials or process steps into the fabrication flow.

One major challenge is the isolation between the various optical components on a PIC. Optical isolators are ubiquitously used in fiber-optic and discrete-optics systems, e.g., to prevent optical feedback from entering a laser cavity. Even minute amounts of coherent feedback, e.g., due to reflections further downstream the system, will increase the laser noise [3]. In silicon and silicon nitride PIC platforms the light source is hybridly integrated in the package, and discrete isolators can be added [4]. However, the indium phosphide and hybrid silicon platforms [5] do not have this option, as the laser is integrated on the PIC. Previous research has clearly shown the limitations due to on-chip optical feedback for tunable lasers [6], mode-locked lasers [7] and wavelength converters [8]. Although by careful design the on-chip reflections can be minimized [9,10], optical isolators with an isolation ratio of around -20 dB are still required.

Efforts to integrate practical optical isolators on a PIC typically include the use of magneto-optic (MO) materials, heterogeneously integrated onto the PIC. With these materials a nonreciprocal absorption [11] or phase shift [12] can be achieved. However, such MO materials are not part of the current PIC foundry platforms. Approaches that are compatible with existing foundry platforms typically make use of time-dependent index or amplitude modulation [13,14].

I will present and discuss two recent approaches to realize PIC foundry-compatible optical isolators. The first is based on hybrid integration of two PICs, using vertical grating couplers for coupling (Fig. 1) [15]. The second approach is based on the timed drive of a pair of optical modulators, with a main application in microwave photonics (Fig. 2) [16].

Partial funding from Det Frie Forskningsråd through the mmW-SPRAWL project (DFF - 4005-00246) is acknowledged.

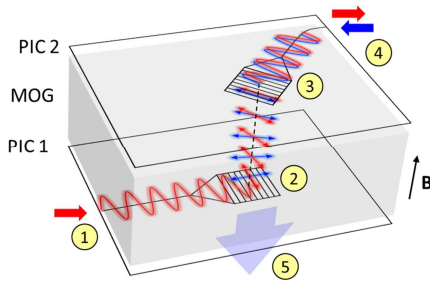


Fig. 3. Magneto-optic garnet (MOG) between two PICs. TE input light (1, red) propagates through first vertical grating coupler (GC, 2), MOG and second GC (3) to output (4). Counter-propagating TE light (blue) does not couple to the input (1), and is radiated out of the plane (5). The magnetic field direction is indicated by B. Picture from [15].

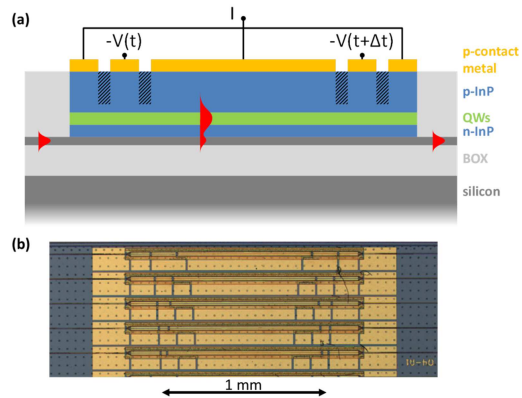


Fig. 4. (a) Hybrid silicon microwave-photonic isolator, showing the optical field (red). Time dependent reverse bias voltage $V(t)$ modulates transmission. (b) Microscope picture of an array of realized devices. Pictures from [16].

References

- [1] J. Sun et al., *Large-scale nanophotonic phased array*, Nature vol. 493, no. 7431, pp. 195-199, 2013
- [2] M. J. R. Heck, *Hybrid and heterogeneous photonic integrated circuits for high-performance applications*, In Proc. SPIE OPTO, pp. 936503-936503, Intern. Soc. for Opt. and Photon., 2015
- [3] R. W. Tkach and A. R. Chraplyvy, *Regimes of feedback effects in 1.5 μm distributed feedback lasers*, Journ. of Lightw. Technol. vol. 4, no. 11, pp. 1655-1661, 1986
- [4] P. De Dobbelaere et al., *Packaging of Silicon Photonics Systems*, In Proc. Optical Fiber Communication Conference, pp. W31-2, Optical Society of America, 2014
- [5] M. J. R. Heck et al., *Hybrid silicon photonic integrated circuit technology*, IEEE Journal of Selected Topics in Quantum Electronics vol. 19, no. 4, 2013
- [6] M. J. R. Heck et al., *Monolithic AWG-based discretely tunable laser diode with nanosecond switching speed*, IEEE Photonics Technology Letters vol. 21, no. 13, pp. 905-907, 2009
- [7] Y. Barbarin et al., *Realization and modeling of a 27-GHz integrated passively mode-locked ring laser*, IEEE Photonics Technology Letters vol. 17, no. 11, pp. 2277-2279, 2005
- [8] M. L. Masanovic et al., *Widely tunable monolithically integrated all-optical wavelength converters in InP*, Journ. of Lightwave Technology vol. 23, no. 3, pp. 1350-1362, 2005
- [9] R. Hanfoug et al., *Reduced reflections from multimode interference couplers*, Electronics Letters vol. 42, no. 8, pp. 465-466, 2006
- [10] G. Kurczveil et al., *Characterization of Insertion Loss and Back Reflection in Passive Hybrid Silicon Tapers*, IEEE Photon. Journ., vol. 5, no. 2, p. 6600410, 2013
- [11] W. Van Parys et al., *Transverse magnetic mode nonreciprocal propagation in an amplifying AlGaInAs/InP optical waveguide isolator*, Appl. Phys. Lett. Vol. 88, no. 7, p. 071115, 2006
- [12] T. Mizumoto et al., *Waveguide optical isolators for integrated optics*, IEEE Journ. Of Quantum Electronics vol. 48, no. 2, pp. 252-260, 2012
- [13] C. R. Doerr et al., *Silicon photonics broadband modulation-based isolator*, Optics Express vol. 22, no. 4, pp. 4493-4498, 2014
- [14] M. J. R. Heck et al., *Monolithic Semiconductor Waveguide Device Concept for Picosecond Pulse Amplification, Isolation and Spectral Shaping*, IEEE J. Quant. Electron. 43, 10, 910-922, 2007
- [15] M. J. R. Heck, *Grating Coupler Enabled Optical Isolators and Circulators for Photonic Integrated Circuits*, IEEE Journ. of Sel. Topics in Quantum Electronics vol. 21, no. 4, pp. 361-369, 2015
- [16] M. J. R. Heck et al., *Integrated Microwave Photonic Isolators: Theory, Experimental Realization and Application in a Unidirectional Ring Mode-Locked Laser Diode*, Photonics 2, 3, 957, 2015